

FDC5661N-F085 Datasheet



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DiGi Electronics Part Number FDC5661N-F085-DG

Manufacturer onsemi

Manufacturer Product Number FDC5661N-F085

Description MOSFET N-CH 60V 4.3A SUPERSOT6

Detailed Description N-Channel 60 V 4.3A (Ta) 1.6W (Ta) Surface Mount

SuperSOT™-6



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RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FDC5661N-F085	onsemi
Series:	Product Status:
PowerTrench®	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
60 V	4.3A (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
4.5V, 10V	47mOhm @ 4.3A, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
3V @ 250μA	19 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	763 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	1.6W (Ta)
Operating Temperature:	Grade:
-55°C ~ 150°C (TJ)	Automotive
Qualification:	Mounting Type:
AEC-Q101	Surface Mount
Supplier Device Package:	Package / Case:
SuperSOT™-6	SOT-23-6 Thin, TSOT-23-6
Base Product Number:	
FDC5661	

Environmental & Export classification

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



MOSFET – N-Channel, Logic Level, POWERTRENCH®

60 V, 4 A, 60 m Ω

FDC5661N-F085

Features

- $R_{DS(on)} = 47 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 4.3 \text{ A}$
- $R_{DS(on)} = 60 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 4 \text{ A}$
- Typ $Q_{g(TOT)} = 14.5 \text{ nC at } V_{GS} = 10 \text{ V}$
- Low Miller Charge
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- DC-DC Converter
- Motor Drives

MOSFET MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain to Source Voltage	V_{DSS}	60	V
Gate to Source Voltage	V _{GS}	±20	V
Drain Current Continuous (V _{GS} = 10 V)	I _D	4.3	Α
Pulsed		20	
Single Pulse Avalanche Energy (Note 1)	E _{AS}	81	mJ
Power Dissipation	P _D	1.6	W
Operating and Storage Temperature	T _J , T _{STG}	–55 to +150	°C
Thermal Resistance Junction to Case	$R_{\theta JC}$	30	°C/W
Thermal Resistance Junction to Ambient TO-263, 1in ² Copper Pad Area	$R_{\theta JA}$	78	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. E_{AS} of 81 mJ is 100% test at L = 14 mH, I_{AS} = 3.4 A, Starting T_{J} = 25°C



TSOT23-6 CASE 419BL

MARKING DIAGRAM



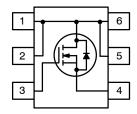
XXX = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS



ORDERING INFORMATION

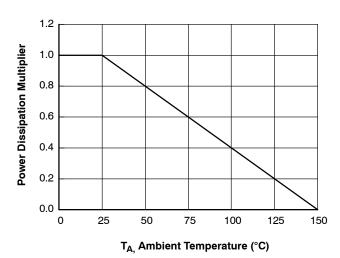
See detailed ordering and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•		•	
Drain to Source Breakdown Voltage	B _{VDSS}	$I_D = 250 \mu A, V_{GS} = 0 V$	60	_	_	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V, V _{GS} = 0 V	-	-	1	μΑ
		T _A = 150°C	-	-	250	
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±20 V	-	-	±100	nA
ON CHARACTERISTICS						
Gate to Source Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1	2.0	3	V
Drain to Source On-Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 4.3 A	-	38	47	mΩ
		V _{GS} = 4.5 V, I _D = 4 A	-	46	60	
		V _{GS} = 10 V, I _D = 4.3 A T _J = 150°C	-	69	86	
DYNAMIC CHARACTERISTICS	-	•	•	-	-	
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V},$ f = 1 MHz	-	763	-	pF
Output Capacitance	C _{oss}	f = 1 MHz	-	68	-	pF
Reverse Transfer Capacitance	C _{rss}		-	36	-	pF
Gate Resistance	R _G	f = 1 MHz	-	2.6	-	Ω
Total Gate Charge at 10 V	Q _{g(TOT)}	$V_{GS} = 0$ to 10 V, $V_{DD} = 30$ V, $I_D = 4.3$ A	۸ –	14.5	19	nC
Gate to Source Gate Charge	Q_{gs}	V _{DD} = 30 V, I _D = 4.3 A	-	2.4	-	nC
Gate to Drain "Miller" Charge	Q_{gd}		-	2.9	-	nC
SWITCHING CHARACTERISTICS	-					
Turn-On Time	t _{on}	$V_{GS} = 10 \text{ V}, V_{DD} = 30 \text{ V},$	-	_	17.6	ns
Turn-On Delay Time	t _{d(on)}	$I_D = 4.3 \text{ A}, R_{GS} = 6 \Omega,$	-	7.2	-	ns
Rise Time	t _r		-	1.6	-	ns
Turn-Off Delay Time	t _{d(off)}		-	19.3	-	ns
Fall Time	t _f		-	3.1	-	ns
Turn-Off Time	t _{off}		_	-	36	ns
DRAIN-SOURCE DIODE CHARACTE	RISTICS			•	•	
Source to Drain Diode Voltage	V _{SD}	I _{SD} = 4.3 A	_	0.8	1.25	V
		I _{SD} = 2.1 A	-	0.8	1.0	
Reverse Recovery Time	t _{rr}	I _{SD} = 4.3 A, dI _{SD} /dt = 100 A/μs	-	18.4	24	ns
Reverse Recovery Charge	Q _{rr}		_	10.0	13	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



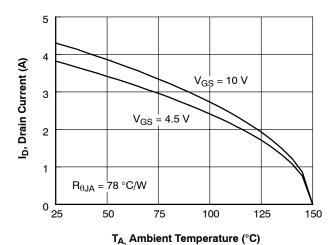


Figure 1. Normalized Power Dissipation vs. Ambient Temperature

Figure 2. Maximum Continuous Drain Current vs. Ambient Temperature

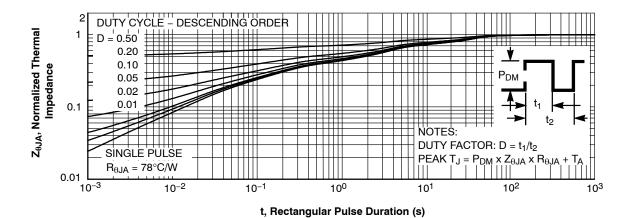


Figure 3. Normalized Maximum Transient Thermal Impedance

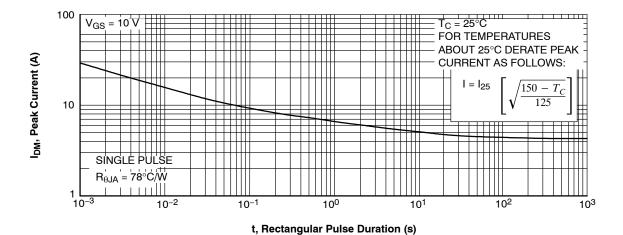


Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (continued)

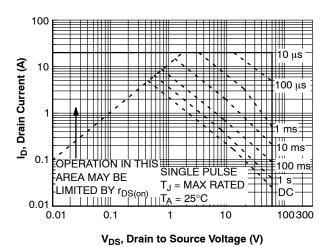


Figure 5. Forward Bias Safe Operating Area

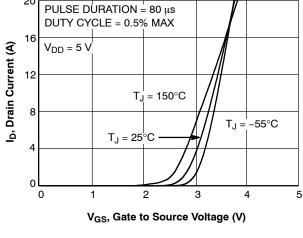


Figure 6. Transfer Characteristics

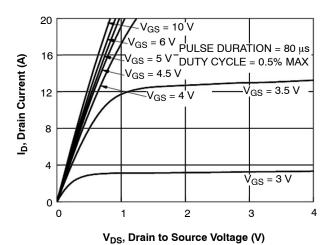


Figure 7. Saturation Characteristics

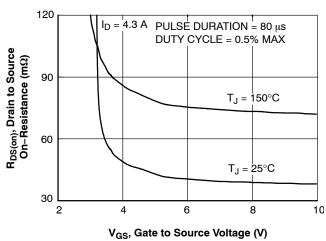


Figure 8. Drain to Source On-Resistance Variation vs. Gate to Source Voltage

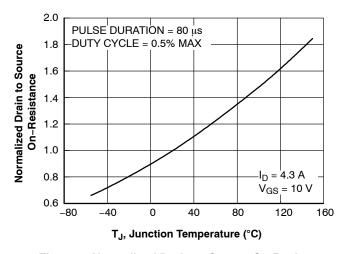


Figure 9. Normalized Drain to Source On Resistance vs. Junction Temperature

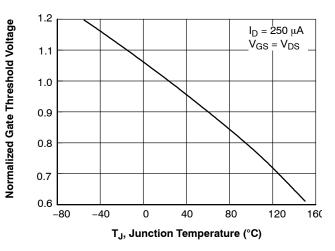
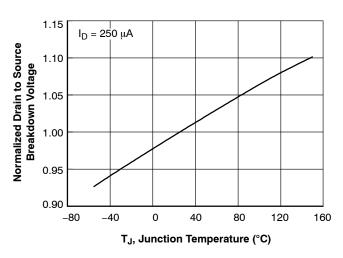


Figure 10. Normalized Gate Threshold Voltage vs. Junction Temperature

TYPICAL CHARACTERISTICS (continued)



2000
1000
1000
1000
C_{iss}
100
C_{ss}
100
C_{ss}
100
0.1 1 10 50
V_{DS}, Drain To Source Voltage (V)

Figure 11. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

Figure 12. Capacitance vs. Drain to Source Voltage

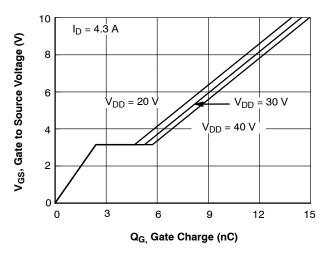


Figure 13. Gate Charge vs. Gate to Source Voltage

ORDERING INFORMATION

Device Marking	Device	Package	Shipping [†]
.661N	FDC5661N-F085	TSOT23-6 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MECHANICAL CASE OUTLINE

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS
 DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS, OR GATE BURRS. MOLD FLASH,

PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.25MM PER END. DIMENSIONS D AND E1 ARE

"A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

e1

L1

L2

θ

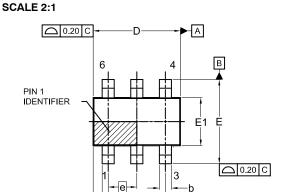
4. SEATING PLANE IS DEFINED BY THE TERMINALS.

DETERMINED AT DATUM H.

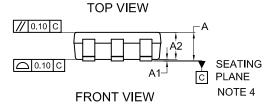
PACKAGE DIMENSIONS

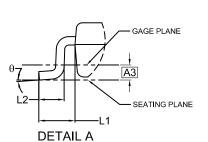
TSOT23 6-Lead CASE 419BL **ISSUE A**

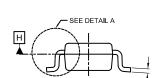
DATE 31 AUG 2020



e1







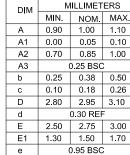
NOTES:

SIDE VIEW O \ / \ 4 \ 4

SYMM				
<u>e</u>				
0.95	95			
1.00 MIN	7			
2	1 2.60			
	<u> </u>			
l 	70 M I N			

LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.



0.20

0°

1.90 BSC

0.60 REF

0.40

0.60 10°

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code Μ

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	TSOT23 6-Lead		PAGE 1 OF 1	

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